

MAX1617

Remote/Local Temperature Sensor with SMBus Serial Interface

General Description

The MAX1617 is a precise digital thermometer that reports the temperature of both a remote sensor and its own package. The remote sensor is a diode-connected transistor—typically a low-cost, easily mounted 2N3904 NPN type—that replaces conventional thermistors or thermocouples. Remote accuracy is $\pm 3^\circ\text{C}$ for multiple transistor manufacturers, with no calibration needed. The remote channel can also measure the die temperature of other ICs, such as microprocessors, that contain an on-chip, diode-connected transistor.

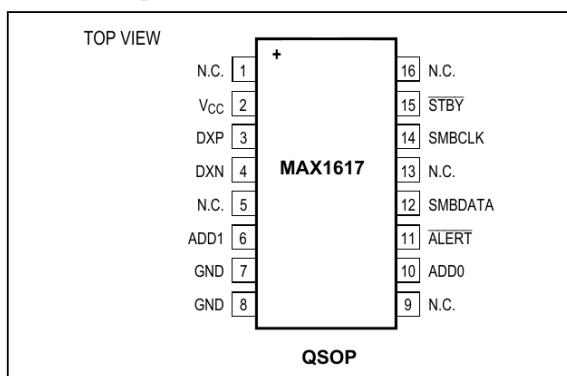
The 2-wire serial interface accepts standard System Management Bus (SMBus) Write Byte, Read Byte, Send Byte, and Receive Byte commands to program the alarm thresholds and to read temperature data. The data format is 7 bits plus sign, with each bit corresponding to 1°C , in two's-complement format. Measurements can be done automatically and autonomously, with the conversion rate programmed by the user or programmed to operate in a single-shot mode. The adjustable rate allows the user to control the supply-current drain.

The MAX1617 is available in a small, 16-pin QSOP surface-mount package.

Applications

- Desktop and Notebook Computers
- Smart Battery Packs
- LAN Servers
- Industrial Controls
- Central Office Telecom Equipment
- Test and Measurement
- Multi-Chip Modules

Pin Configuration



Features

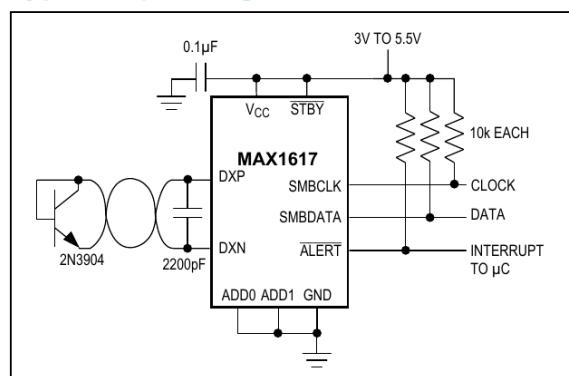
- Two Channels: Measures Both Remote and Local Temperatures
- No Calibration Required
- SMBus 2-Wire Serial Interface
- Programmable Under/Overtemperature Alarms
- Supports SMBus Alert Response
- Accuracy:
 - $\pm 2^\circ\text{C}$ ($+60^\circ\text{C}$ to $+100^\circ\text{C}$, local)
 - $\pm 3^\circ\text{C}$ (-40°C to $+125^\circ\text{C}$, local)
 - $\pm 3^\circ\text{C}$ ($+60^\circ\text{C}$ to $+100^\circ\text{C}$, remote)
- 3 μA (typ) Standby Supply Current
- 70 μA (max) Supply Current in Auto-Convert Mode
- +3V to +5.5V Supply Range
- Small, 16-Pin QSOP Package

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX1617MEE+	-55°C to +125°C	16 QSOP

+Denotes a lead-free package.

Typical Operating Circuit



Electrical Characteristics (continued)(V_{CC} = +3.3V, T_A = 0°C to +85°C, unless otherwise noted.) (Note 1)

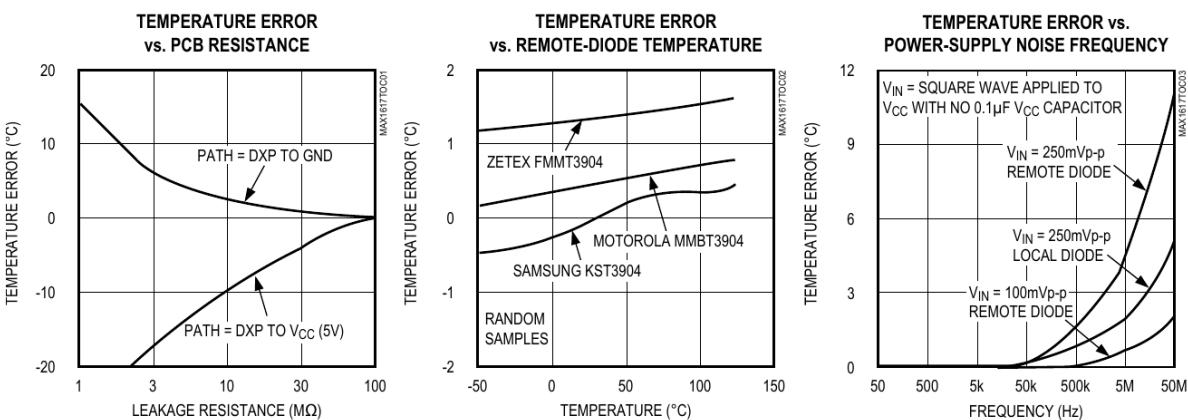
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SMBus INTERFACE					
Logic Input High Voltage	STBY, SMBCLK, SMBDATA; V _{CC} = 3V to 5.5V	2.2			V
Logic Input Low Voltage	STBY, SMBCLK, SMBDATA; V _{CC} = 3V to 5.5V		0.8		V
Logic Output Low Sink Current	ALERT, SMBDATA forced to 0.4V	6			mA
ALERT Output High Leakage Current	ALERT forced to 5.5V		1		μA
Logic Input Current	Logic inputs forced to V _{CC} or GND	-1	1		μA
SMBus Input Capacitance	SMBCLK, SMBDATA		5		pF
SMBus Clock Frequency	(Note 5)	DC	100		kHz
SMBCLK Clock Low Time	t _{LOW} , 10% to 10% points	4.7			μs
SMBCLK Clock High Time	t _{HIGH} , 90% to 90% points	4			μs
SMBus Start-Condition Setup Time		4.7			μs
SMBus Repeated Start-Condition Setup Time	t _{SU:STA} , 90% to 90% points	500			ns
SMBus Start-Condition Hold Time	t _{HD:STA} , 10% of SMBDATA to 90% of SMBCLK	4			μs
SMBus Stop-Condition Setup Time	t _{SU:STO} , 90% of SMBCLK to 10% of SMBDATA	4			μs
SMBus Data Valid to SMBCLK Rising-Edge Time	t _{SU:DAT} , 10% or 90% of SMBDATA to 10% of SMBCLK	800			ns
SMBus Data-Hold Time	t _{HD:DAT} (Note 6)	0			μs
SMBCLK Falling Edge to SMBus Data-Valid Time	Master clocking in data		1		μs

Electrical Characteristics(V_{CC} = +3.3V, T_A = 5.5°C to +125°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
ADC AND POWER SUPPLY					
Temperature Resolution (Note 1)	Monotonicity guaranteed	8			Bits
Initial Temperature Error, Local Diode (Note 3)	T _A = +60°C to +100°C	-2	2		°C
	T _A = 0°C to +85°C	-3	3		
Temperature Error, Remote Diode (Notes 3 and 4)	T _R = +60°C to +100°C	-3	3		°C
	T _R = -55°C to +125°C	-5	5		
Supply-Voltage Range		3.0	5.5		V
Conversion Time	From stop bit to conversion complete (both channels)	94	125	156	ms
Conversion Rate Timing Error	Auto-convert mode	-25	25		%

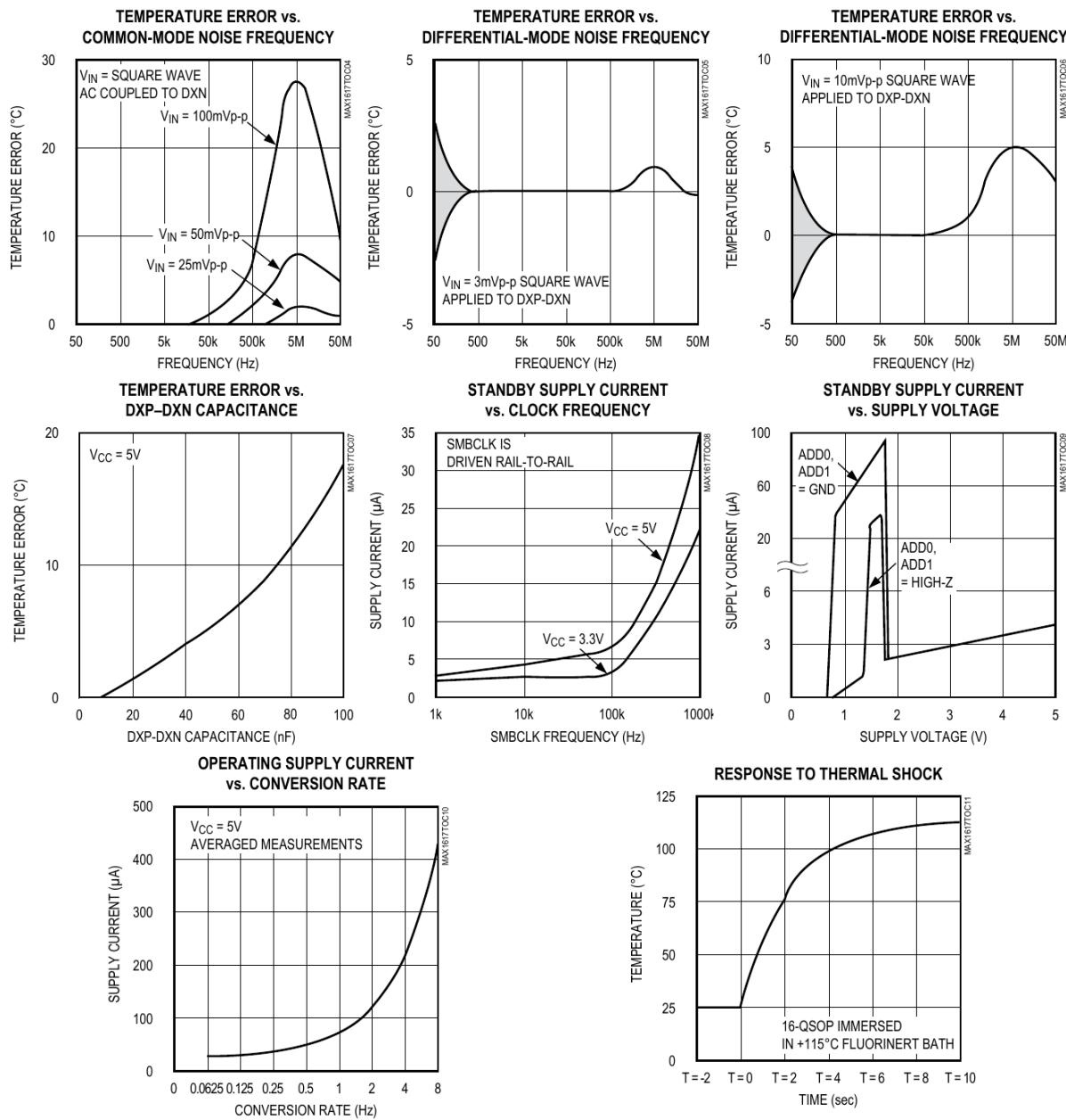
Electrical Characteristics (continued)(V_{CC} = +3.3V, T_A = 5.5°C to +125°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SMBus INTERFACE					
Logic Input High Voltage	STBY, SMBCLK, SMBDATA	V _{CC} = 3V	2.2		V
Logic Input Low Voltage		V _{CC} = 5.5V	2.4		
Logic Output Low Sink Current	ALERT, SMBDATA forced to 0.4V		6		mA
ALERT Output High Leakage Current	ALERT forced to 5.5V			1	μA
Logic Input Current	Logic inputs forced to V _{CC} or GND	-2	2		μA

Note 1: All devices 100% production tested at T_A = +85°C. Limits over temperature are guaranteed by design.**Note 2:** Guaranteed but not 100% tested.**Note 3:** Quantization error is not included in specifications for temperature accuracy. For example, if the MAX1617 device temperature is exactly +66.7°C, the ADC may report +66°C, +67°C, or +68°C (due to the quantization error plus the +1/2°C offset used for rounding up) and still be within the guaranteed ±1°C error limits for the +60°C to +100°C temperature range. See Table 2.**Note 4:** A remote diode is any diode-connected transistor from Table 1. T_R is the junction temperature of the remote diode. See *Remote Diode Selection* for remote diode forward voltage requirements.**Note 5:** The SMBus logic block is a static design that works with clock frequencies down to DC. While slow operation is possible, it violates the 10kHz minimum clock frequency and SMBus specifications, and may monopolize the bus.**Note 6:** Note that a transition must internally provide at least a hold time in order to bridge the undefined region (300ns max) of SMBCLK's falling edge.**Typical Operating Characteristics**(T_A = +25°C, unless otherwise noted.)

Typical Operating Characteristics (continued)

(TA = +25°C, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION
1, 5, 9, 13, 16	N.C.	No Connection. Not internally connected. May be used for PCB trace routing.
2	V _{CC}	Supply Voltage Input, 3V to 5.5V. Bypass to GND with a 0.1µF capacitor. A 200Ω series resistor is recommended but not required for additional noise filtering.
3	D _{XP}	Combined Current Source and A/D Positive Input for remote-diode channel. Do not leave D _{XP} unconnected; tie D _{XP} to D _{XN} if no remote diode is used. Place a 2200pF capacitor between D _{XP} and D _{XN} for noise filtering.
4	D _{XN}	Combined Current Sink and A/D Negative Input. D _{XN} is normally biased to a diode voltage above ground.
6	ADD1	SMBus Address Select pin (Table 8). ADD0 and ADD1 are sampled upon power-up. Excess capacitance (>50pF) at the address pins when unconnected may cause address-recognition problems.
7, 8	GND	Ground
10	ADD0	SMBus Slave Address Select pin
11	ALERT	SMBus Alert (interrupt) Output, open drain
12	SMBDATA	SMBus Serial-Data Input/Output, open drain
14	SMBCLK	SMBus Serial-Clock Input
15	STBY	Hardware Standby Input. Temperature and comparison threshold data are retained in standby mode. Low = standby mode, high = operate mode.

Detailed Description

The MAX1617 is a temperature sensor designed to work in conjunction with an external microcontroller (µC) or other intelligence in thermostatic, process-control, or monitoring applications. The µC is typically a power-management or keyboard controller, generating SMBus serial commands by “bit-banging” general-purpose input-output (GPIO) pins or via a dedicated SMBus interface block.

Essentially an 8-bit serial analog-to-digital converter (ADC) with a sophisticated front end, the MAX1617 contains a switched current source, a multiplexer, an ADC, an SMBus interface, and associated control logic (Figure 1). Temperature data from the ADC is loaded into two data registers, where it is automatically compared with data previously stored in four over/under-temperature alarm registers.

ADC and Multiplexer

The ADC is an averaging type that integrates over a 60ms period (each channel, typical), with excellent noise rejection.

The multiplexer automatically steers bias currents through the remote and local diodes, measures their forward voltages, and computes their temperatures. Both channels are automatically converted once the conversion process has started, either in free-running or single-shot mode. If one of the two channels is not used, the device still performs both measurements, and the user can simply ignore the results of the unused channel. If the remote diode channel is unused, tie D_{XP} to D_{XN} rather than leaving the pins open.

The D_{XN} input is biased at 0.65V typical above ground by an internal diode to set up the analog-to-digital (A/D) inputs for a differential measurement. The typical D_{XP}-D_{XN} differential input voltage range is 0.25V to 0.95V. To ensure proper operation over full temperature range, ensure $V_{DXP} \leq (0.78 \times V_{CC} - 1.1)$ volts.

Excess resistance in series with the remote diode causes about +1/2°C error per ohm. Likewise, 200µV of offset voltage forced on D_{XP}-D_{XN} causes about 1°C error.

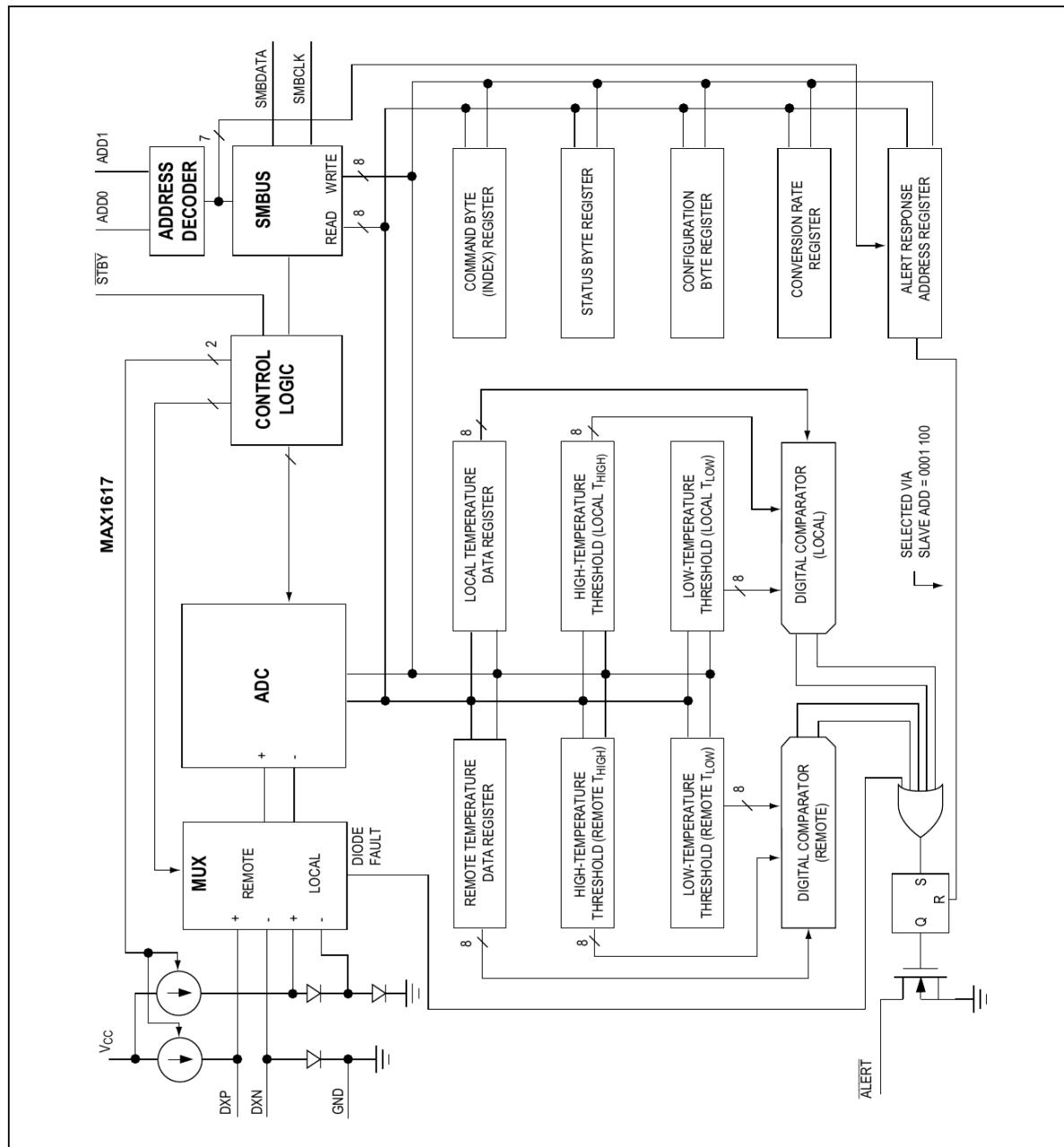


Figure 1. Functional Diagram

A/D Conversion Sequence

If a Start command is written (or generated automatically in the free-running auto-convert mode), both channels are converted, and the results of both measurements are available after the end of conversion. A BUSY status bit in the status byte shows that the device is actually performing a new conversion; however, even if the ADC is busy, the results of the previous conversion are always available.

Remote-Diode Selection

Temperature accuracy depends on having a good-quality, diode-connected small-signal transistor. See Table 1 for a recommended list of diode-connected small-signal transistors. The MAX1617 can also directly measure the die temperature of CPUs and other integrated circuits having on-board temperature-sensing diodes.

The transistor must be a small-signal type with a relatively high forward voltage; otherwise, the A/D input voltage range can be violated. The forward voltage must be greater than 0.25V at 10 μ A; check to ensure this is true at the highest expected temperature. The forward voltage ($V_{DXP} - V_{DXN}$) must be less than 0.95V at 100 μ A; additionally, ensure the maximum V_{DXP} (DXP voltage) $\leq (0.78 \times V_{CC} - 1.1)$ volts over your expected range of temperature. Large power transistors don't work at all. Also, ensure that the base resistance is less than 100 Ω . Tight specifications for forward-current gain (+50 to +150, for example) indicate that the manufacturer has good process controls and that the devices have consistent VBE characteristics.

For heat-sink mounting, the 500-32BT02-000 thermal sensor from Fenwal Electronics is a good choice. This device consists of a diode-connected transistor, an aluminum plate with screw hole, and twisted-pair cable (Fenwal Inc., Milford, MA, 508-478-6000).

Thermal Mass and Self-Heating

Thermal mass can seriously degrade the MAX1617's effective accuracy. The thermal time constant of the QSOP-16 package is about 140sec in still air. For the MAX1617 junction temperature to settle to within +1°C after a sudden +100°C change requires about five time constants or 12 minutes. The use of smaller packages for remote sensors, such as SOT23s, improves the situation. Take care to account for thermal gradients between the heat source and the sensor, and ensure that stray air currents across the sensor package do not interfere with measurement accuracy.

Table 1. Remote-Sensor Transistor Manufacturers

MANUFACTURER	MODEL NUMBER
Central Semiconductor (USA)	CMPT3904
Motorola (USA)	MMBT3904
National Semiconductor (USA)	MMBT3904
Rohm Semiconductor (Japan)	SST3904
Samsung (Korea)	KST3904-TF
Siemens (Germany)	SMBT3904
Zetex (England)	FMMT3904CT-ND

Note: Transistors must be diode-connected (base shorted to collector).

Self-heating does not significantly affect measurement accuracy. Remote-sensor self-heating due to the diode current source is negligible. For the local diode, the worst-case error occurs when auto-converting at the fastest rate and simultaneously sinking maximum current at the ALERT output. For example, at an 8Hz rate and with ALERT sinking 1mA, the typical power dissipation is $V_{CC} \times 450\mu A$ plus $0.4V \times 1mA$. Package theta J-A is about 150°C/W, so with $V_{CC} = 5V$ and no copper PCB heatsinking, the resulting temperature rise is:

$$dT = 2.7mW \times 150^{\circ}\text{C}/W = 0.4^{\circ}\text{C}$$

Even with these contrived circumstances, it is difficult to introduce significant self-heating errors.

ADC Noise Filtering

The ADC is an integrating type with inherently good noise rejection, especially of low-frequency signals such as 60Hz/120Hz power-supply hum. Micropower operation places constraints on high-frequency noise rejection; therefore, careful PCB layout and proper external noise filtering are required for high-accuracy remote measurements in electrically noisy environments.

High-frequency EMI is best filtered at DXP and DXN with an external 2200pF capacitor. This value can be increased to about 3300pF (max), including cable capacitance. Higher capacitance than 3300pF introduces errors due to the rise time of the switched current source.

Nearly all noise sources tested cause the ADC measurements to be higher than the actual temperature, typically by +1°C to +10°C, depending on the frequency and amplitude (see *Typical Operating Characteristics*).

PCB Layout

- 1) Place the MAX1617 as close as practical to the remote diode. In a noisy environment, such as a computer motherboard, this distance can be 4 in. to 8 in. (typical) or more as long as the worst noise sources (such as CRTs, clock generators, memory buses, and ISA/PCI buses) are avoided.
- 2) Do not route the DXP–DXN lines next to the deflection coils of a CRT. Also, do not route the traces across a fast memory bus, which can easily introduce +30°C error, even with good filtering. Otherwise, most noise sources are fairly benign.
- 3) Route the DXP and DXN traces in parallel and in close proximity to each other, away from any high-voltage traces such as +12VDC. Leakage currents from PCB contamination must be dealt with carefully, since a 20MΩ leakage path from DXP to ground causes about +1°C error.
- 4) Connect guard traces to GND on either side of the DXP–DXN traces (Figure 2). With guard traces in place, routing near high-voltage traces is no longer an issue.
- 5) Route through as few vias and crossunders as possible to minimize copper/solder thermocouple effects.
- 6) When introducing a thermocouple, make sure that both the DXP and the DXN paths have matching thermocouples. In general, PCB-induced thermocouples are not a serious problem. A copper-solder thermocouple exhibits 3µV/°C, and it takes about 200µV of voltage error at DXP–DXN to cause a +1°C measurement error. So, most parasitic thermocouple errors are swamped out.
- 7) Use wide traces. Narrow ones are more inductive and tend to pick up radiated noise. The 10 mil widths and spacings recommended in Figure 2 aren't absolutely necessary (as they offer only a minor improvement in leakage and noise), but try to use them where practical.
- 8) Keep in mind that copper can't be used as an EMI shield, and only ferrous materials such as steel work well. Placing a copper ground plane between the DXP–DXN traces and traces carrying high-frequency noise signals does not help reduce EMI.

PCB Layout Checklist

- Place the MAX1617 close to a remote diode.
- Keep traces away from high voltages (+12V bus).
- Keep traces away from fast data buses and CRTs.
- Use recommended trace widths and spacings.
- Place a ground plane under the traces.

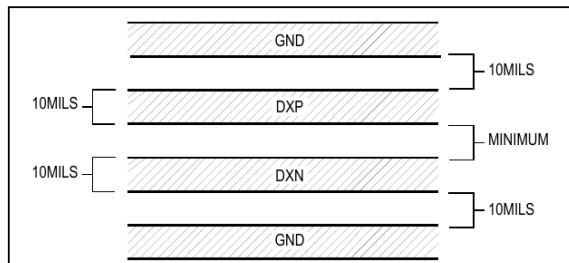


Figure 2. Recommended DXP/DXN PC Traces

- Use guard traces flanking DXP and DXN and connecting to GND.
- Place the noise filter and the 0.1µF V_{CC} bypass capacitors close to the MAX1617.
- Add a 200Ω resistor in series with V_{CC} for best noise filtering (see Typical Operating Circuit).

Twisted Pair and Shielded Cables

For remote-sensor distances longer than 8 in., or in particularly noisy environments, a twisted pair is recommended. Its practical length is 6 feet to 12 feet (typical) before noise becomes a problem, as tested in a noisy electronics laboratory. For longer distances, the best solution is a shielded twisted pair like that used for audio microphones. For example, Belden #8451 works well for distances up to 100 feet in a noisy environment. Connect the twisted pair to DXP and DXN and the shield to GND, and leave the shield's remote end unterminated.

Excess capacitance at DX_{_} limits practical remote sensor distances (see *Typical Operating Characteristics*). For very long cable runs, the cable's parasitic capacitance often provides noise filtering, so the 2200pF capacitor can often be removed or reduced in value.

Cable resistance also affects remote-sensor accuracy; 1Ω series resistance introduces about +1/2°C error.

Low-Power Standby Mode

Standby mode disables the ADC and reduces the supply-current drain to less than 10µA. Enter standby mode by forcing the STBY pin low or via the RUN/STOP bit in the configuration byte register. Hardware and software standby modes behave almost identically: all data is retained in memory, and the SMB interface is alive and listening for reads and writes. The only difference is that in hardware standby mode, the one-shot command does not initiate a conversion.

Standby mode is not a shutdown mode. With activity on the SMBus, extra supply current is drawn (see *Typical Operating Characteristics*). In software standby mode,

the MAX1617 can be forced to perform A/D conversions via the one-shot command, despite the RUN/STOP bit being high.

Activate hardware standby mode by forcing the **STBY** pin low. In a notebook computer, this line may be connected to the system SUSTAT# suspend-state signal.

The **STBY** pin low state overrides any software conversion command. If a hardware or software standby command is received while a conversion is in progress, the conversion cycle is truncated, and the data from that conversion is not latched into either temperature reading register. The previous data is not changed and remains available.

Supply-current drain during the 125ms conversion period is always about 450µA. Slowing down the conversion rate reduces the average supply current (see *Typical Operating Characteristics*). In between conversions, the instantaneous supply current is about 25µA due to the current consumed by the conversion rate timer. In standby mode, supply current drops to about 3µA. At very low supply voltages (under the power-on-reset threshold), the supply current is higher due to the address pin bias currents. It can be as high as 100µA, depending on ADD0 and ADD1 settings.

SMBus Digital Interface

From a software perspective, the MAX1617 appears as a set of byte-wide registers that contain temperature data, alarm threshold values, or control bits. A standard SMBus 2-wire serial interface is used to read temperature data and write control bits and alarm threshold data. Each A/D channel within the device responds to the same SMBus slave address for normal reads and writes.

The MAX1617 employs four standard SMBus protocols: Write Byte, Read Byte, Send Byte, and Receive Byte (Figure 3). The shorter Receive Byte protocol allows quicker transfers, provided that the correct data register was previously selected by a Read Byte instruction. Use caution with the shorter protocols in multi-master systems, since a second master could overwrite the command byte without informing the first master.

The temperature data format is 7 bits plus sign in two's-complement form for each channel, with each data bit representing 1°C (Table 2), transmitted MSB first. Measurements are offset by +1/2°C to minimize internal rounding errors; for example, +99.6°C is reported as +100°C.

Write Byte Format									
S	ADDRESS	WR	ACK	COMMAND	ACK	DATA	ACK	P	
	7 bits			8 bits		8 bits		1	
Slave Address: equivalent to chip-select line of a 3-wire interface			Command Byte: selects which register you are writing to			Data Byte: data goes into the register set by the command byte (to set thresholds, configuration masks, and sampling rate)			
Read Byte Format									
S	ADDRESS	WR	ACK	COMMAND	ACK	S	ADDRESS	RD	ACK
	7 bits			8 bits			7 bits		8 bits
Slave Address: equivalent to chip-select line			Command Byte: selects which register you are reading from			Slave Address: repeated due to change in data-flow direction			Data Byte: reads from the register set by the command byte
Send Byte Format									
S	ADDRESS	WR	ACK	COMMAND	ACK	P			
	7 bits			8 bits					
Command Byte: sends command with no data, usually used for one-shot command			Data Byte: reads data from the register commanded by the last Read Byte or Write Byte transmission; also used for SMBus Alert Response return address						
S = Start condition P = Stop condition									
Shaded = Slave transmission /// = Not acknowledged									

Figure 3. SMBus Protocols

Table 4. Command-Byte Bit Assignments

REGISTER	COMMAND	POR STATE	FUNCTION
RLTS	00h	0000 0000*	Read local temperature: returns latest temperature
RRTE	01h	0000 0000*	Read remote temperature: returns latest temperature
RSL	02h	N/A	Read status byte (flags, busy signal)
RCL	03h	0000 0000	Read configuration byte
RCRA	04h	0000 0010	Read conversion rate byte
RLHN	05h	0111 1111	Read local T_{HIGH} limit
RLLI	06h	1100 1001	Read local T_{LOW} limit
RRHI	07h	0111 1111	Read remote T_{HIGH} limit
RRLS	08h	1100 1001	Read remote T_{LOW} limit
WCA	09h	N/A	Write configuration byte
WCRW	0Ah	N/A	Write conversion rate byte
WLHO	0Bh	N/A	Write local T_{HIGH} limit
WLLM	0Ch	N/A	Write local T_{LOW} limit
WRHA	0Dh	N/A	Write remote T_{HIGH} limit
WRLN	0Eh	N/A	Write remote T_{LOW} limit
OSHT	0Fh	N/A	One-shot command (use send-byte format)

*If the device is in hardware standby mode at POR, both temperature registers read 0°C.

The Alert Response can activate several different slave devices simultaneously, similar to the I²C General Call. If more than one slave attempts to respond, bus arbitration rules apply, and the device with the lower address code wins. The losing device does not generate an acknowledge and continues to hold the ALERT line low until serviced (implies that the host interrupt input is level-sensitive). Successful reading of the alert response address clears the interrupt latch.

Command Byte Functions

The 8-bit command byte register (Table 4) is the master index that points to the various other registers within the MAX1617. The register's POR state is 0000 0000, so that a Receive Byte transmission (a protocol that lacks the command byte) that occurs immediately after POR returns the current local temperature data.

The one-shot command immediately forces a new conversion cycle to begin. In software standby mode (RUN/STOP bit = high), a new conversion is begun, after which the device returns to standby mode. If a conversion is in progress when a one-shot command is received, the command is ignored. If a one-shot command is received in auto-convert mode (RUN/STOP bit = low) between conversions, a new conversion begins, the conversion rate timer is reset, and the next automatic conversion takes place after a full delay elapses.

Configuration Byte Functions

The configuration byte register (Table 5) is used to mask (disable) interrupts and to put the device in software standby mode. The lower six bits are internally set to (XX1111), making them "don't care" bits. Write zeros to these bits. This register's contents can be read back over the serial interface.

Status Byte Functions

The status byte register (Table 6) indicates which (if any) temperature thresholds have been exceeded. This byte also indicates whether or not the ADC is converting and whether there is an open circuit in the remote diode DXP–DXN path. After POR, the normal state of all the flag bits is zero, assuming none of the alarm conditions are present. The status byte is cleared by any successful read of the status byte, unless the fault persists. Note that the ALERT interrupt latch is not automatically cleared when the status flag bit is cleared.

When reading the status byte, you must check for internal bus collisions caused by asynchronous ADC timing, or else disable the ADC prior to reading the status byte (via the RUN/STOP bit in the configuration byte). In one-shot mode, read the status byte only after the conversion is complete, which is 150ms max after the one-shot conversion is commanded.

Table 5. Configuration-Byte Bit Assignments

BIT	NAME	POR STATE	FUNCTION
7 (MSB)	MASK	0	Masks all ALERT interrupts when high.
6	RUN/STOP	0	Standby mode control bit. If high, the device immediately stops converting and enters standby mode. If low, the device converts in either one-shot or timer mode.
5-0	RFU	0	Reserved for future use

Table 6. Status-Byte Bit Assignments

BIT	NAME	FUNCTION
7 (MSB)	BUSY	A high indicates that the ADC is busy converting.
6	LHIGH*	A high indicates that the local hightemperature alarm has activated.
5	LLOW*	A high indicates that the local lowtemperature alarm has activated.
4	RHIGH*	A high indicates that the remote hightemperature alarm has activated.
3	RLOW*	A high indicates that the remote lowtemperature alarm has activated.
2	OPEN*	A high indicates a remote-diode continuity (open-circuit) fault.
1	RFU	Reserved for future use (returns 0)
0 (LSB)	RFU	Reserved for future use (returns 0)

*These flags stay high until cleared by POR, or until the status byte register is read.

To check for internal bus collisions, read the status byte. If the least significant seven bits are ones, discard the data and read the status byte again. The status bits LHIGH, LLOW, RHIGH, and RLOW are refreshed on the SMBus clock edge immediately following the stop condition, so there is no danger of losing temperature-related status data as a result of an internal bus collision. The OPEN status bit (diode continuity fault) is only refreshed at the beginning of a conversion, so OPEN data is lost. The

Table 7. Conversion-Rate Control Byte

DATA	CONVERSION RATE (Hz)	AVERAGE SUPPLY CURRENT (µA typ, at V _{CC} = 3.3V)
00h	0.0625	30
01h	0.125	33
02h	0.25	35
03h	0.5	48
04h	1	70
05h	2	128
06h	4	225
07h	8	425
08h to FFh	RFU	—

ALERT interrupt latch is independent of the status byte register, so no false alerts are generated by an internal bus collision.

When auto-converting, if the THIGH and TLOW limits are close together, it's possible for both high-temp and low-temp status bits to be set, depending on the amount of time between status read operations (especially when converting at the fastest rate). In these circumstances, it's best not to rely on the status bits to indicate reversals in long-term temperature changes and instead use a current temperature reading to establish the trend direction.

Conversion Rate Byte

The conversion rate register (Table 7) programs the time interval between conversions in free-running auto-convert mode. This variable rate control reduces the supply current in portable-equipment applications. The conversion rate byte's POR state is 02h (0.25Hz). The MAX1617 looks only at the 3 LSB bits of this register, so the upper 5 bits are "don't care" bits, which should be set to zero. The conversion rate tolerance is ±25% at any rate setting.

Valid A/D conversion results for both channels are available one total conversion time (125ms nominal, 156ms maximum) after initiating a conversion, whether conversion is initiated via the RUN/STOP bit, hardware STBY pin, one-shot command, or initial power-up. Changing the conversion rate can also affect the delay until new results are available. See Table 8.

Table 8. RLTS and RRTE Temp Register Update Timing Chart

OPERATING MODE	CONVERSION INITIATED BY:	NEW CONVERSION RATE (CHANGED VIA WRITE TO WCRW)	TIME UNTIL RLTS AND RRTE ARE UPDATED
Auto-Convert	Power-on reset	n/a (0.25Hz)	156ms max
Auto-Convert	1-shot command, while idling between automatic conversions	n/a	156ms max
Auto-Convert	1-shot command that occurs during a conversion	n/a	When current conversion is complete (1-shot is ignored)
Auto-Convert	Rate timer	0.0625Hz	20sec
Auto-Convert	Rate timer	0.125Hz	10sec
Auto-Convert	Rate timer	0.25Hz	5sec
Auto-Convert	Rate timer	0.5Hz	2.5sec
Auto-Convert	Rate timer	1Hz	1.25sec
Auto-Convert	Rate timer	2Hz	625ms
Auto-Convert	Rate timer	4Hz	312.5ms
Auto-Convert	Rate timer	8Hz	237.5ms
Hardware Standby	STBY pin	n/a	156ms
Software Standby	RUN/STOP bit	n/a	156ms
Software Standby	1-shot command	n/a	156ms

Slave Addresses

The MAX1617 appears to the SMBus as one device having a common address for both ADC channels. The device address can be set to one of nine different values by pin-strapping ADD0 and ADD1 so that more than one MAX1617 can reside on the same bus without address conflicts (Table 9).

The address pin states are checked at POR only, and the address data stays latched to reduce quiescent supply current due to the bias current needed for high-Z state detection.

The MAX1617 also responds to the SMBus Alert Response slave address (see the *Alert Response Address* section).

POR and UVLO

The MAX1617 has a volatile memory. To prevent ambiguous power-supply conditions from corrupting the data in memory and causing erratic behavior, a POR voltage detector monitors V_{CC} and clears the memory if V_{CC} falls below 1.7V (typical, see *Electrical Characteristics* table). When power is first applied and V_{CC} rises above 1.75V (typical), the logic blocks begin operating, although reads and writes at V_{CC} levels below 3V are not recommended. A second V_{CC} comparator, the ADC UVLO comparator, prevents the ADC from converting until there is sufficient headroom ($V_{CC} = 2.8V$ typical).

**Table 9. Slave Address Decoding (ADD0
and ADD1)**

ADD0	ADD1	ADDRESS
GND	GND	0011 000
GND	High-Z	0011 001
GND	V_{CC}	0011 010
High-Z	GND	0101 001
High-Z	High-Z	0101 010
High-Z	V_{CC}	0101 011
V_{CC}	GND	1001 100
V_{CC}	High-Z	1001 101
V_{CC}	V_{CC}	1001 110

Note: High-Z means that the pin is left unconnected.

Power-Up Defaults:

- Interrupt latch is cleared.
- Address select pins are sampled.
- ADC begins auto-converting at a 0.25Hz rate.
- Command byte is set to 00h to facilitate quick remote Receive Byte queries.
- T_{HIGH} and T_{LOW} registers are set to max and min limits, respectively.

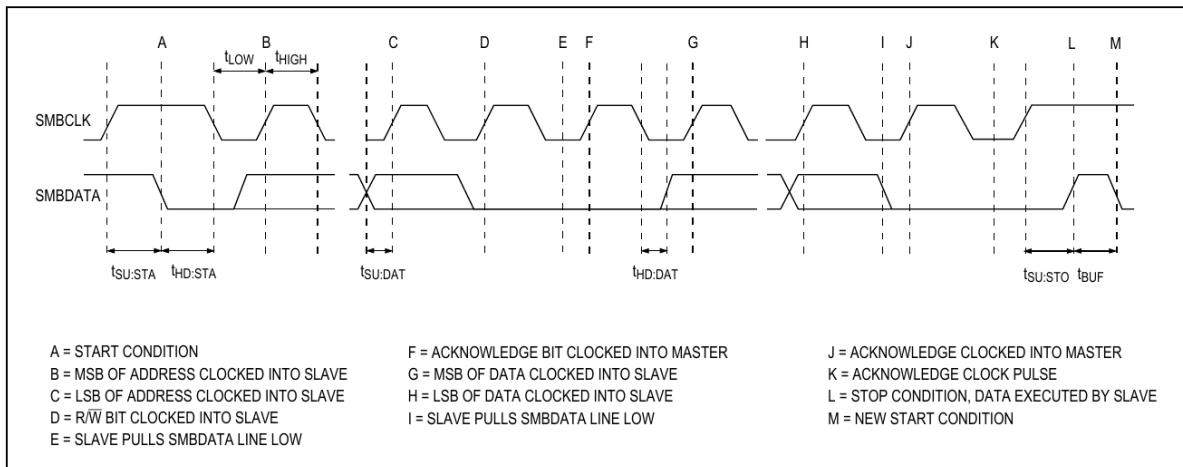


Figure 4. SMBus Write Timing Diagram

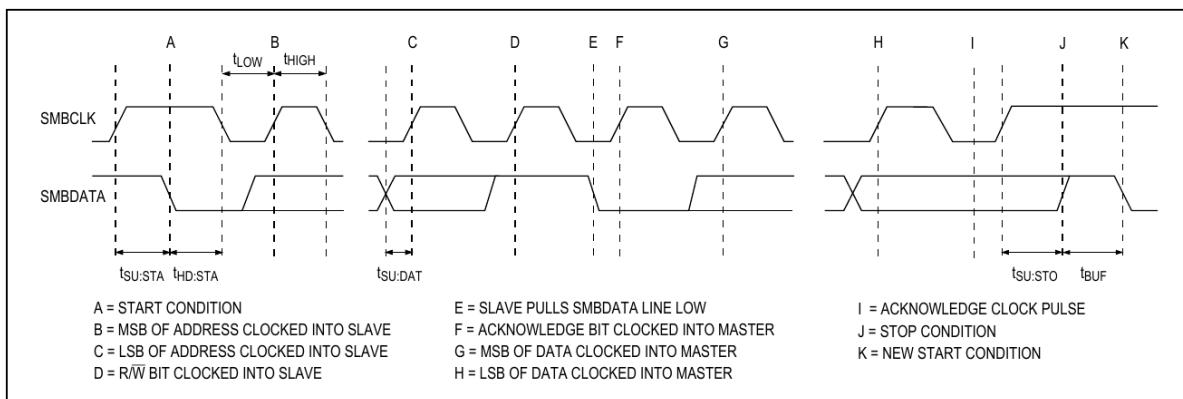


Figure 5. SMBus Read Timing Diagram

Programming Example: Clock-Throttling Control for CPUs

An untested example of pseudocode for proportional temperature control of Intel mobile CPUs via a power-management microcontroller is given in Listing 1. This program consists of two main parts: an initialization routine and an interrupt handler. The initialization routine checks for SMBus communications problems and sets up the MAX1617 configuration and conversion rate. The interrupt handler responds to ALERT signals by reading the current temperature and setting a CPU clock duty

factor proportional to that temperature. The relationship between clock duty and temperature is fixed in a lookup table contained in the microcontroller code.

Note: Thermal management decisions should be made based on the latest temperature obtained from the MAX1617 rather than the value of the Status Byte. The MAX1617 has a very quick response to changes in its environment due to its sensitivity and its small thermal mass. High and low alarm conditions can exist in the Status Byte due to the MAX1617 correctly reporting environmental changes around it.

```

/* Beginning of the header file which sets the constants */

int      NumStates      = 10;
int      RRTE           = 1;    /* 0x01, command for reading remote temp register */
int      WCA             = 9;   /* 0x09, command for writing configuration register */
int      WCRW            = 10;  /* 0x0A, command for writing conversion rate register */
int      RSL             = 2;   /* 0x02, command for reading status register */
int      WRHA            = 13;  /* 0x0D, command for writing remote THIGH limit register */
int      WRLN            = 14;  /* 0x0E, command for writing remote TLOW limit register */
int      NoError          = 0;
int      Nobody          = 0;
int      MAX1617Addr     = 84;  /* 0x54, default address for MAX1617, ADD0,ADD1=open */
int      InitConfig       = 0;   /* 0x00, configure MAX1617 to MASK=0 and RUN/STOP=0 */
int      InitConv          = 7;   /* 0x07, conversion rate of 8Hz */
int      HighAdder        = 2;   /* 2oC offset for calculating THIGH limit */
int      LowSubtractor     = 4;   /* 4oC offset for calculating TLOW limit */
int      CollisionMask     = 1;   /* 0x01, mask for status bit that indicates collision */
int      DiodeFaultMask   = 4;   /* 0x04, mask for the OPEN diode fault status bit */
int      TempChangeMask    = 24;  /* 0x18, mask for RHIGH and RLLOW status bits */

array  State[0..NumStates] of int;

State[0] = -65 oC          /* At or above this temperature CPU duty cycle is 100% */
State[1] = 72 oC           /* At or above this temperature CPU duty cycle is 87.5% */
State[2] = 74 oC           /* At or above this temperature CPU duty cycle is 75% */
State[3] = 76 oC           /* At or above this temperature CPU duty cycle is 62.5% */
State[4] = 78 oC           /* At or above this temperature CPU duty cycle is 50% */
State[5] = 80 oC           /* At or above this temperature CPU duty cycle is 37.5% */
State[6] = 82 oC           /* At or above this temperature CPU duty cycle is 25% */
State[7] = 84 oC           /* At or above this temperature CPU duty cycle is 12.5% */
State[8] = 86 oC           /* At or above this temperature CPU duty cycle is 0.0% */
State[9] = 88 oC           /* At or above this temperature SHUT SYSTEM OFF! */
State[10] = 127 oC          /* Extra array location so looping is easier */

array  ClockRate[0..NumStates] of real;

ClockRate[0]   = 1.0;
ClockRate[1]   = 0.875;
ClockRate[2]   = 0.75;
ClockRate[3]   = 0.625;
ClockRate[4]   = 0.5;
ClockRate[5]   = 0.375;
ClockRate[6]   = 0.25;
ClockRate[7]   = 0.125;
ClockRate[8]   = 0;
ClockRate[9]   = 0;
ClockRate[10]  = 0;

/* End of the header file */

```

Listing 1. Pseudocode Example

```
int Initialization()
{
    int ErrorCode = NoError;
    /* Test the SMBus communications path to the MAX1617 by writing the configuration,
    conversion rate and initial temperature limits; if SMBus communication was unsuccessful,
    power the system down. Note that the MAX1617Write procedure takes three parameters: the
    command code of the register to be written, the data to write, and a pointer to the error
    code variable. If the error code variable does not equal NoError before the
    execution of MAX1617Write, MAX1617Write does nothing. If the SMBus communication fails in
    MAX1617Write, the error code variable is set to the type of error (for example a NACK,
    i.e. MAX1617 did not acknowledge). This code assumes that the BIOS is already in thermal
    state 0 (not throttling, i.e. full CPU clock rate) when the initialization routine is
    executed. */

    MAX1617Write(WCA, InitConfig, &ErrorCode); /* MASK=0 and RUN/STOP=0 */
    MAX1617Write(WCRW, InitConv, &ErrorCode); /* CONV = 8Hz */
    MAX1617Write(WRLN, LowestTemp, &ErrorCode); /* TLLOW = -65oC */
    MAX1617Write(WRHA, State[0] + HighAdder, &ErrorCode) /* THIGH = 72oC */
    if (ErrorCode != NoError) {
        /* Power off the system */
    } /* End of if (ErrorCode ... */
    return (ErrorCode);

/* After changing the conversion rate to 8Hz, the MAX1617 temperature register will not
have valid (i.e. current temperature) data for 238 milliseconds. */
} /* End of Initialization routine */
```

Listing 1. Pseudocode Example (continued)

```

int ALERT_IntHandler()
{
    int ErrorCode = NoError;
    int WhoDunnit = Nobody;
    int FoundState = 0;
    int StatusInfo = 0;
    int TempHigh;
    int TempLow;

    /* This interrupt handler verifies that the MAX1617 is the source of the interrupt (and
       also clears the interrupt) via the SMBus Alert Response address; checks the status byte to
       ensure that a temperature change did indeed cause the interrupt; reads the remote
       temperature; programs a corresponding clock-throttling duty cycle, and sets up new Thigh
       and Tlow limits. */

    ReadAlertResponse(&WhoDunnit, &ErrorCode);
    if (WhoDunnit == MAX1617Addr) then {

        MAX1617Read(RSL, &StatusInfo, &ErrorCode);

        if (((StatusInfo & CollisionMask) != 0) and (ErrorCode == NoError)) then
            MAX1617Read(RSL, &StatusInfo, &ErrorCode);

        if (StatusInfo & DiodeFaultMask) != 0) then {
            /* Shut down system because thermal diode doesn't work */

        }
        else if ((StatusInfo & TempChangeMask) != 0) then {

            MAX1617Read(RRTE, &TempRead, &ErrorCode);
            while ((TempRead >= State[FoundState + 1]) and
                   (FoundState < (NumStates - 1))) do FoundState++;
            if (FoundState == (NumStates - 1)) then {
                /* Ahhhhhh!!! SHUT SYSTEM OFF!!!! */
            }
            else {
                /* adjust clock duty cycle */
                TempHigh = TempRead + HighAdder;
                TempLow = TempRead - LowSubtractor;
                MAX1617Write(WRHA, TempHigh, &Error);
                MAX1617Write(WRLN, TempLow, &Error);
            } /* End of if (FoundState ... */

        } /* End of if (((StatusInfo .. else if ... */

        /* Handle local temp status bits if set */

    }
    else {
        /* Handle cases for other interrupt sources */
    } /* End of if (WhoDunnit ... */

    return(ErrorCode);
} /* End of Alert_IntHandler interrupt handler routine */

```

Listing 1. Pseudocode Example (continued)

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
16 QSOP	E116+1	21-0055	90-0167

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	11/12	Updated <i>Electrical Characteristics</i> tables (added new Note 1); updated <i>ADC and Multiplexer</i> and <i>Remote-Diode Selection</i> sections	2–4, 6, 8
3	11/16	Removed 200Ω resistor from <i>Typical Operating Circuit</i>	1

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